

STARPOWER

SEMICONDUCTOR

IGBT

GD820HTA75P6H

750V/820A 6 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as hybrid and electric vehicle.

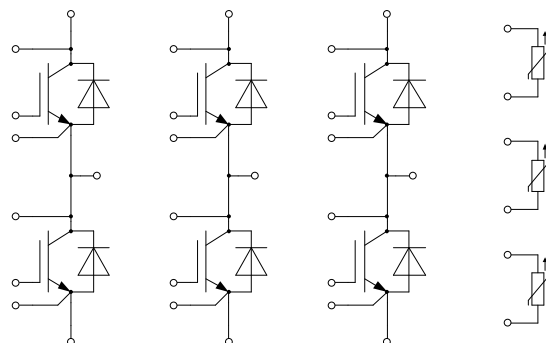
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- Low switching losses
- 6 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper pinfin baseplate using DBC technology

Typical Applications

- Automotive application
- Hybrid and electric vehicle
- Inverter for motor drive

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_F=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

| Symbol | Description | Values | Unit |
|-----------|---|----------|------|
| V_{CES} | Collector-Emitter Voltage | 750 | V |
| V_{GES} | Gate-Emitter Voltage | ± 20 | V |
| I_{CN} | Implemented Collector Current | 820 | A |
| I_C | Collector Current @ $T_F=90^{\circ}\text{C}$ | 450 | A |
| I_{CM} | Pulsed Collector Current $t_p=1\text{ms}$ | 1640 | A |
| P_D | Maximum Power Dissipation @ $T_F=75^{\circ}\text{C}$ $T_j=175^{\circ}\text{C}$ | 751 | W |

Diode

| Symbol | Description | Values | Unit |
|-----------|--|--------|------|
| V_{RRM} | Repetitive Peak Reverse Voltage | 750 | V |
| I_{FN} | Implemented Collector Current | 820 | A |
| I_F | Diode Continuous Forward Current | 450 | A |
| I_{FM} | Diode Maximum Forward Current $t_p=1\text{ms}$ | 1640 | A |

Module

| Symbol | Description | Value | Unit |
|------------|---|-----------------------------|--------------------|
| T_{jmax} | Maximum Junction Temperature | 175 | $^{\circ}\text{C}$ |
| T_{jop} | Operating Junction Temperature continuous For 10s within a period of 30s, occurrence maximum 3000 times over lifetime | -40 to +150 +150 to +175 | $^{\circ}\text{C}$ |
| T_{STG} | Storage Temperature Range | -40 to +125 | $^{\circ}\text{C}$ |
| V_{ISO} | Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$ | 2500 | V |

IGBT Characteristics $T_F=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---------------|---|---|------|------|------|---------------|
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=450\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$ | | 1.10 | 1.35 | V |
| | | $I_C=450\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$ | | 1.15 | | |
| | | $I_C=450\text{A}, V_{GE}=15\text{V}, T_j=175^\circ\text{C}$ | | 1.15 | | |
| | | $I_C=820\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$ | | 1.30 | | |
| | | $I_C=820\text{A}, V_{GE}=15\text{V}, T_j=175^\circ\text{C}$ | | 1.50 | | |
| $V_{GE(th)}$ | Gate-Emitter Threshold Voltage | $I_C=12.9\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$ | 5.5 | 6.5 | 7.0 | V |
| I_{CES} | Collector Cut-Off Current | $V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$ | | | 1.0 | mA |
| I_{GES} | Gate-Emitter Leakage Current | $V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$ | | | 400 | nA |
| R_{Gint} | Internal Gate Resistance | | | 1.0 | | Ω |
| C_{ies} | Input Capacitance | | | 72.3 | | nF |
| C_{oes} | Output Capacitance | $V_{CE}=50\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$ | | 1.51 | | nF |
| C_{res} | Reverse Transfer Capacitance | $V_{GE}=0\text{V}$ | | 0.32 | | nF |
| Q_G | Gate Charge | $V_{CE}=400\text{V}, I_C=450\text{A}, V_{GE}=-15\dots+15\text{V}$ | | 4.77 | | μC |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, V_{GE}=-8\text{V}/+15\text{V}, L_S=24\text{nH}, T_j=25^\circ\text{C}$ | | 315 | | ns |
| t_r | Rise Time | | | 61 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 729 | | ns |
| t_f | Fall Time | | | 70 | | ns |
| E_{on} | Turn-On Switching Loss | | | 12.4 | | mJ |
| E_{off} | Turn-Off Switching Loss | | 18.3 | | mJ | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, V_{GE}=-8\text{V}/+15\text{V}, L_S=24\text{nH}, T_j=150^\circ\text{C}$ | | 338 | | ns |
| t_r | Rise Time | | | 74 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 826 | | ns |
| t_f | Fall Time | | | 151 | | ns |
| E_{on} | Turn-On Switching Loss | | | 20.7 | | mJ |
| E_{off} | Turn-Off Switching Loss | | 25.3 | | mJ | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{CC}=400\text{V}, I_C=450\text{A}, R_G=2.4\Omega, V_{GE}=-8\text{V}/+15\text{V}, L_S=24\text{nH}, T_j=175^\circ\text{C}$ | | 343 | | ns |
| t_r | Rise Time | | | 77 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 846 | | ns |
| t_f | Fall Time | | | 171 | | ns |
| E_{on} | Turn-On Switching Loss | | | 25.0 | | mJ |
| E_{off} | Turn-Off Switching Loss | | 27.3 | | mJ | |
| I_{SC} | SC Data | $t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}, V_{CC}=400\text{V}, V_{CEM} \leq 750\text{V}$ | | 4500 | | A |

| | | | | | | |
|--|--|--|--|------|--|--|
| | | $t_p \leq 3\mu s, V_{GE}=15V,$ $T_j=175^\circ C, V_{CC}=400V,$ $V_{CEM} \leq 750V$ | | 3300 | | |
|--|--|--|--|------|--|--|

Diode Characteristics $T_F=25^\circ C$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-----------|-------------------------------|---|------|------|------|---------|
| V_F | Diode Forward Voltage | $I_F=450A, V_{GE}=0V, T_j=25^\circ C$ | | 1.40 | 1.65 | V |
| | | $I_F=450A, V_{GE}=0V, T_j=150^\circ C$ | | 1.35 | | |
| | | $I_F=450A, V_{GE}=0V, T_j=175^\circ C$ | | 1.30 | | |
| | | $I_F=820A, V_{GE}=0V, T_j=25^\circ C$ | | 1.70 | | |
| | | $I_F=820A, V_{GE}=0V, T_j=175^\circ C$ | | 1.65 | | |
| Q_r | Recovered Charge | | | 10.1 | | μC |
| I_{RM} | Peak Reverse Recovery Current | $V_R=400V, I_F=450A,$ $-di/dt=7760A/\mu s, V_{GE}=-8V$ | | 287 | | A |
| E_{rec} | Reverse Recovery Energy | $L_S=24nH, T_j=25^\circ C$ | | 4.83 | | mJ |
| Q_r | Recovered Charge | | | 25.6 | | μC |
| I_{RM} | Peak Reverse Recovery Current | $V_R=400V, I_F=450A,$ $-di/dt=6300A/\mu s, V_{GE}=-8V$ | | 341 | | A |
| E_{rec} | Reverse Recovery Energy | $L_S=24nH, T_j=150^\circ C$ | | 9.32 | | mJ |
| Q_r | Recovered Charge | | | 30.4 | | μC |
| I_{RM} | Peak Reverse Recovery Current | $V_R=400V, I_F=450A,$ $-di/dt=5990A/\mu s, V_{GE}=-8V$ | | 354 | | A |
| E_{rec} | Reverse Recovery Energy | $L_S=24nH, T_j=175^\circ C$ | | 10.6 | | mJ |

NTC Characteristics $T_F=25^\circ C$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|--------------|------------------------|---|------|------|------|------------|
| R_{25} | Rated Resistance | | | 5.0 | | k Ω |
| $\Delta R/R$ | Deviation of R_{100} | $T_C=100^\circ C, R_{100}=493.3\Omega$ | -5 | | 5 | % |
| P_{25} | Power Dissipation | | | | 20.0 | mW |
| $B_{25/50}$ | B-value | $R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15K))]$ | | 3375 | | K |
| $B_{25/80}$ | B-value | $R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15K))]$ | | 3411 | | K |
| $B_{25/100}$ | B-value | $R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15K))]$ | | 3433 | | K |

Module Characteristics $T_F=25^{\circ}\text{C}$ unless otherwise noted

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
|---------------|--|------------|----------------|----------------|------------|
| L_{CE} | Stray Inductance | | 8 | | nH |
| $R_{CC'+EE'}$ | Module Lead Resistance, Terminal to Chip | | 0.75 | | m Ω |
| Δp | $\Delta V/\Delta t=10.0\text{dm}^3/\text{min}, T_F=75^{\circ}\text{C}$ | | 64 | | mbar |
| p | Maximum Pressure In Cooling Circuit $T_{\text{baseplate}} < 40^{\circ}\text{C}$ $T_{\text{baseplate}} > 40^{\circ}\text{C}$ (relative pressure) | | | 2.5 2.0 | bar |
| R_{thJF} | Junction-to-Cooling Fluid (per IGBT) Junction-to-Cooling Fluid (per Diode) $\Delta V/\Delta t=10.0\text{dm}^3/\text{min}, T_F=75^{\circ}\text{C}$ | | 0.116 0.175 | 0.133 0.200 | K/W |
| M | Terminal Connection Torque, Screw M5 Mounting Torque, Screw M4 | 3.6 1.8 | | 4.4 2.2 | N.m |
| G | Weight of Module | | 750 | | g |

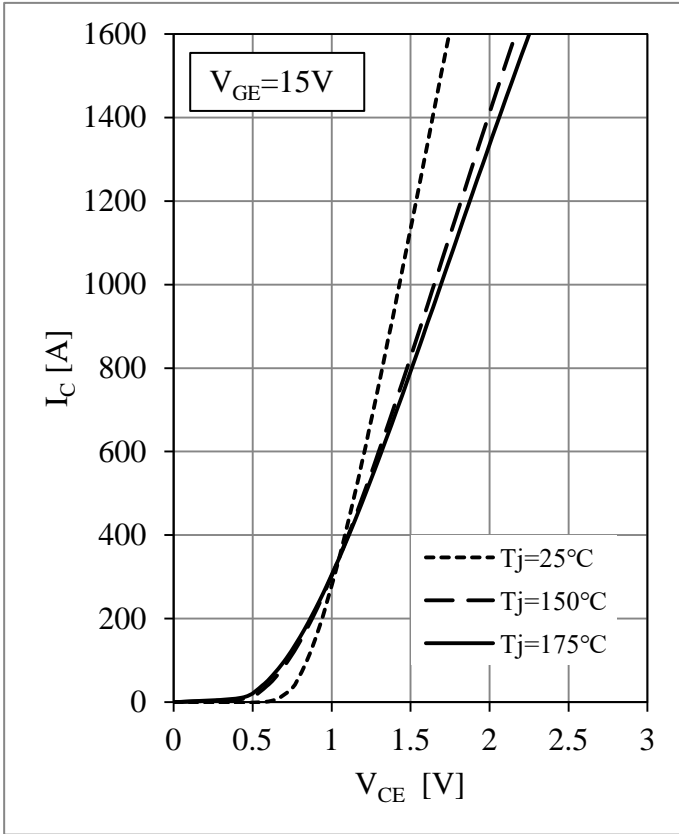


Fig 1. IGBT Output Characteristics

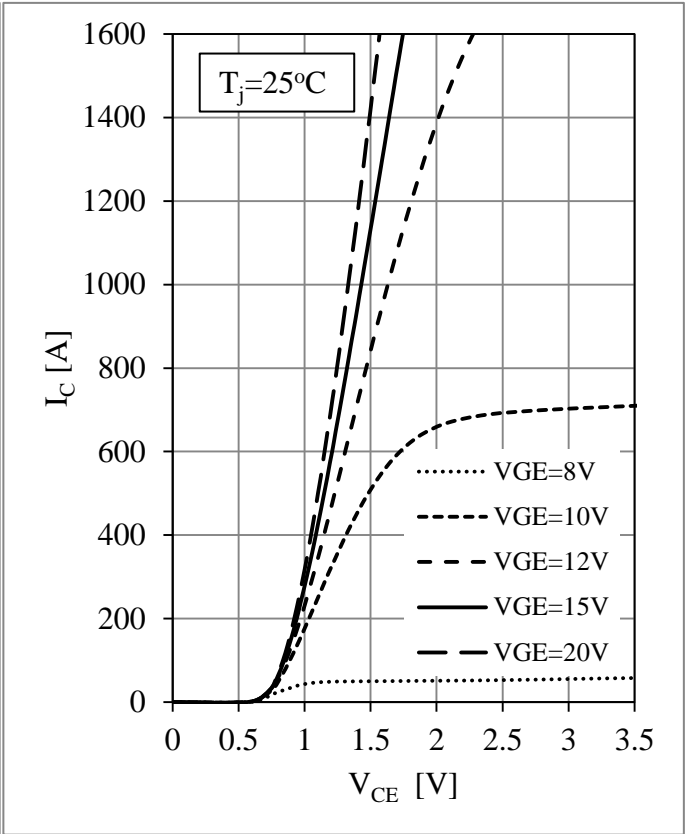


Fig 2. IGBT Output Characteristics

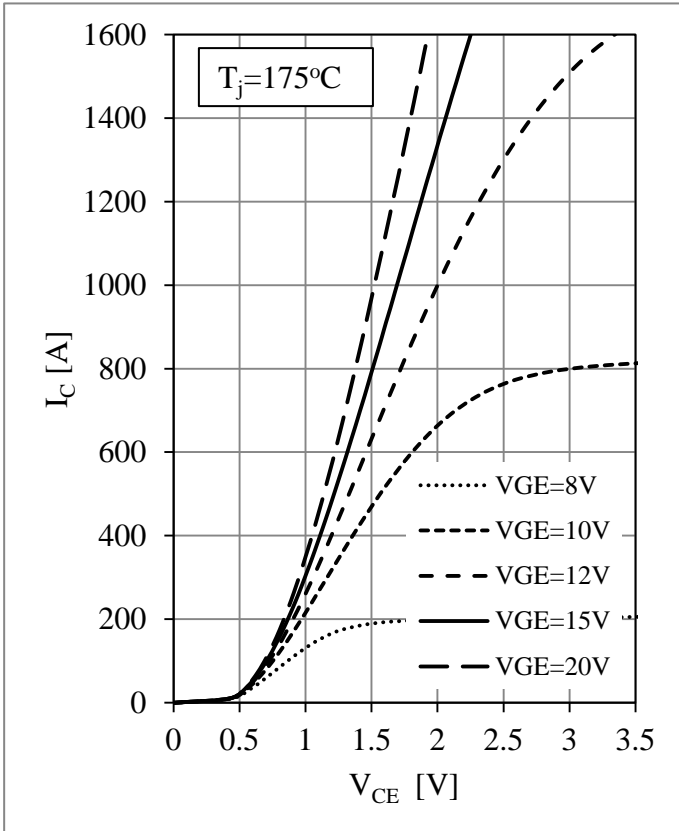


Fig 3. IGBT Output Characteristics

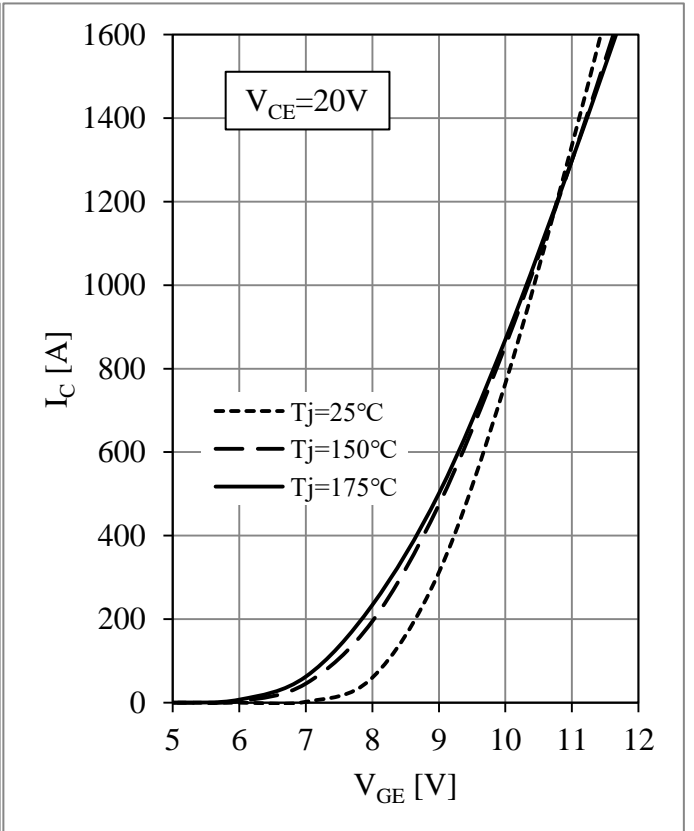


Fig 4. IGBT Transfer Characteristics

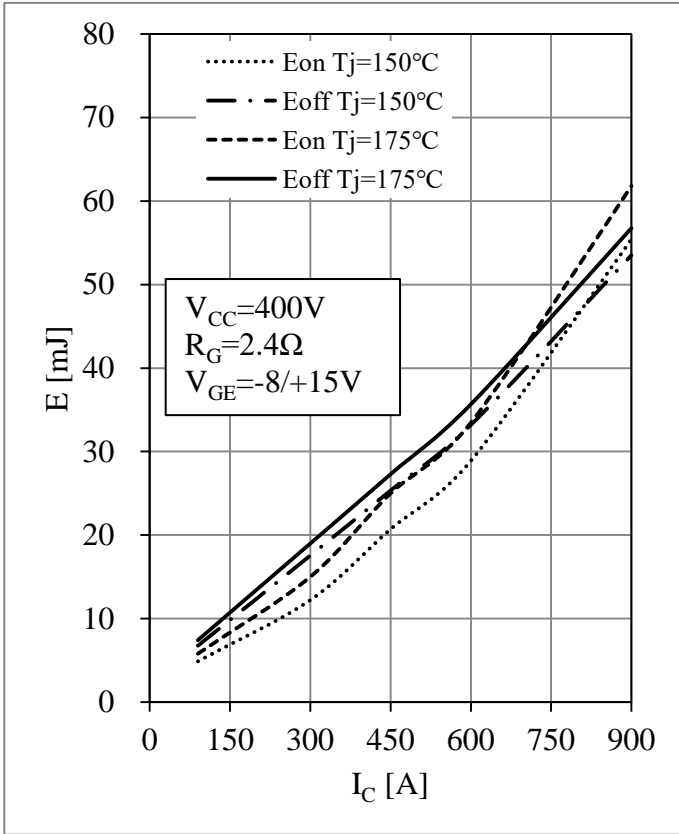


Fig 5. IGBT Switching Loss vs. I_C

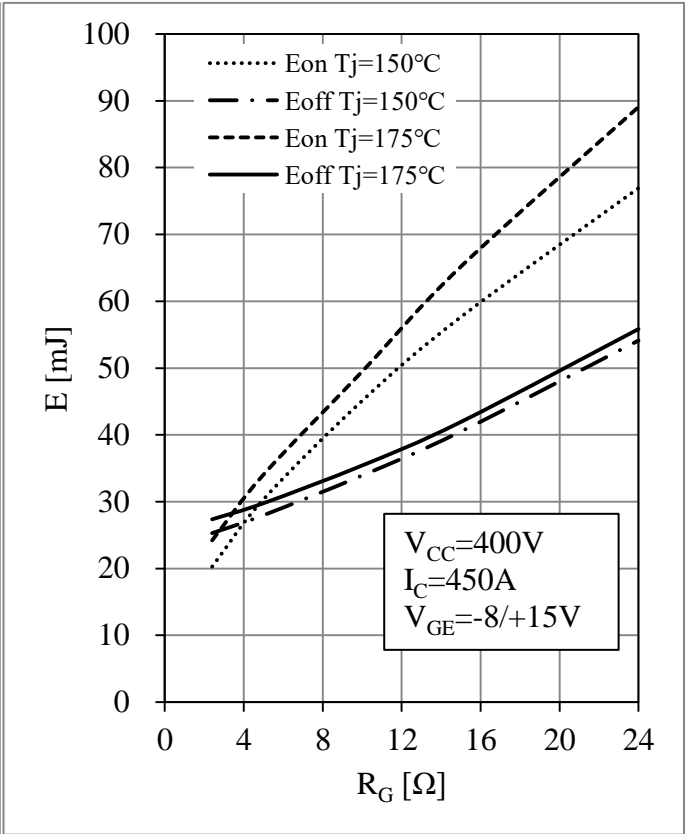


Fig 6. IGBT Switching Loss vs. R_G

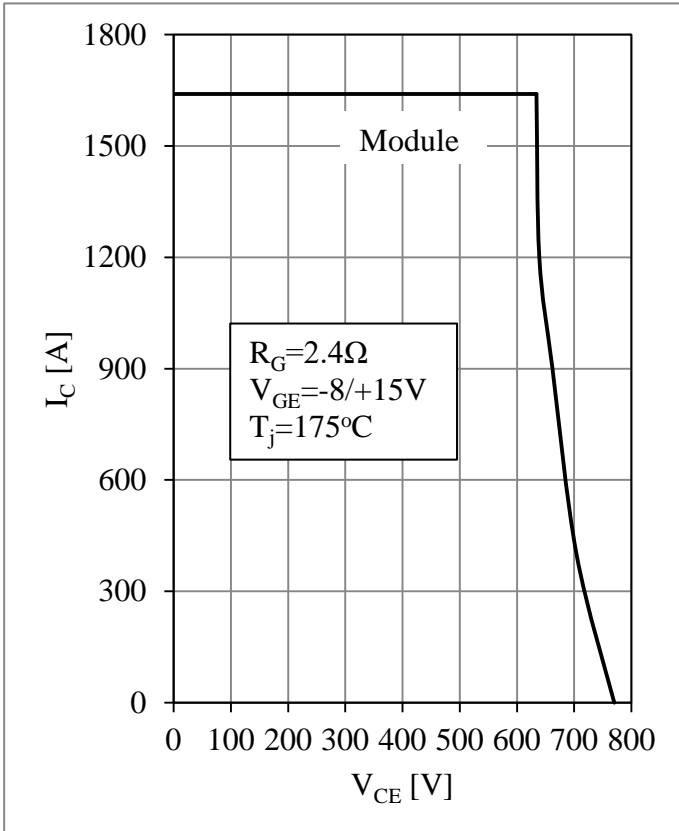


Fig 7. RBSOA

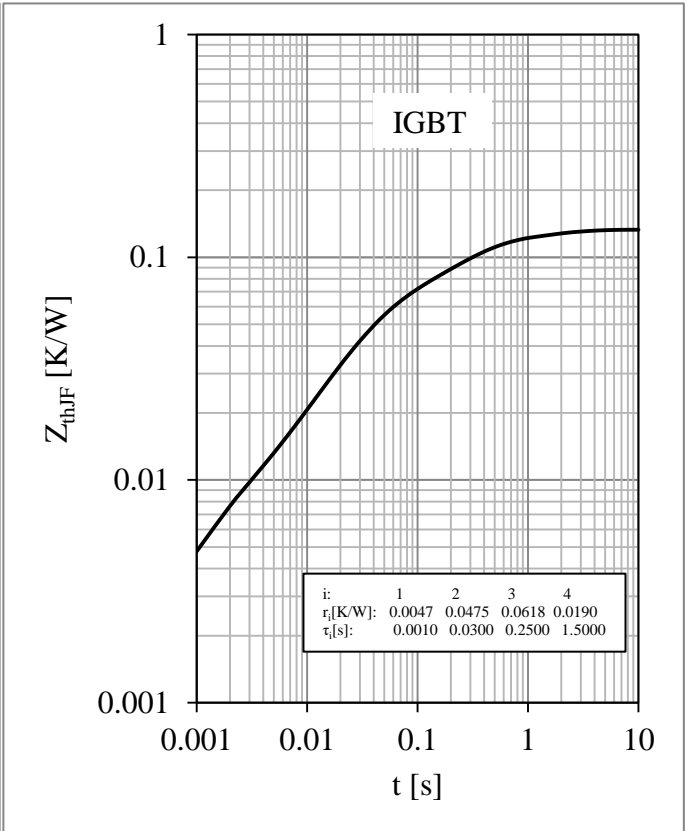


Fig 8. IGBT Transient Thermal Impedance

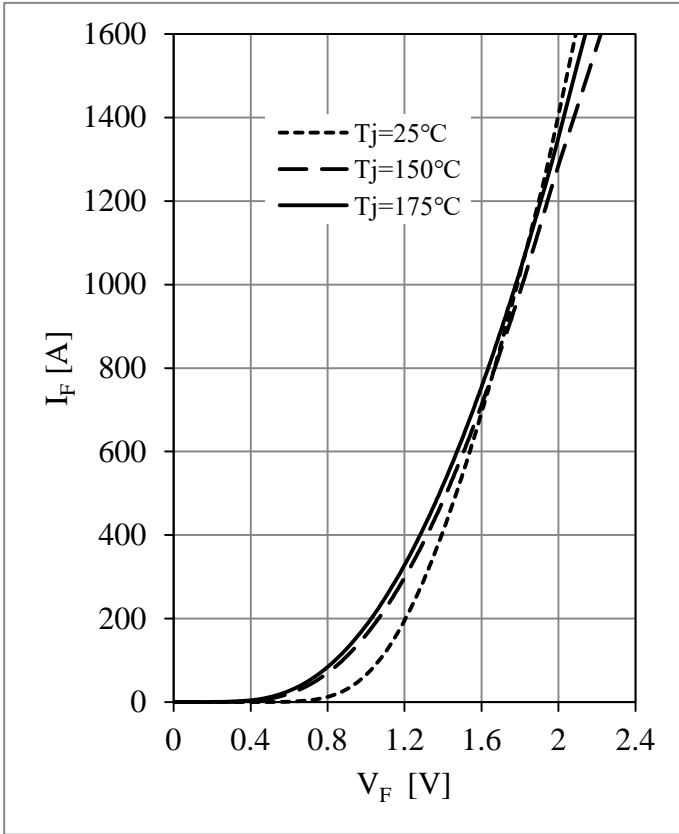


Fig 9. Diode Forward Characteristics

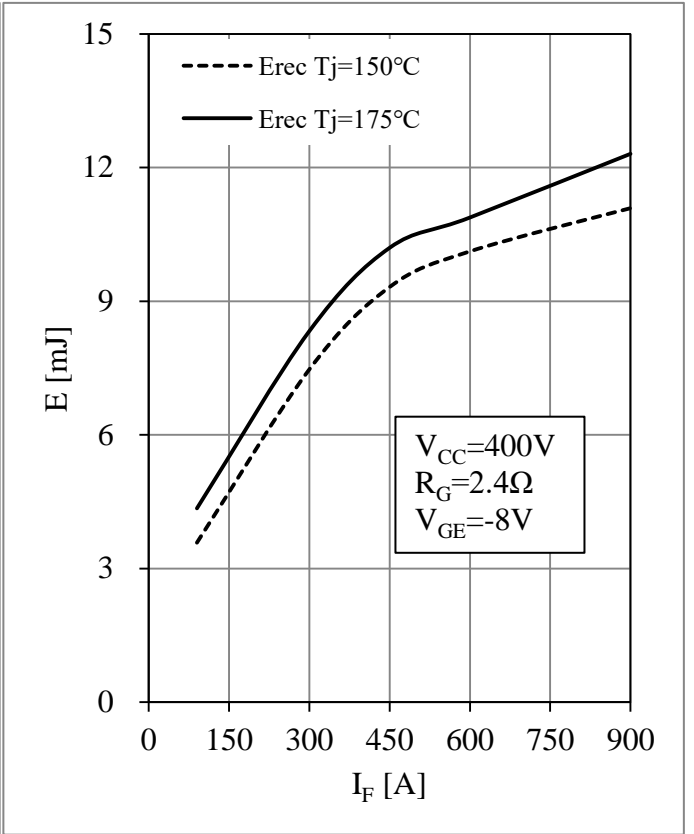


Fig 10. Diode Switching Loss vs. I_F

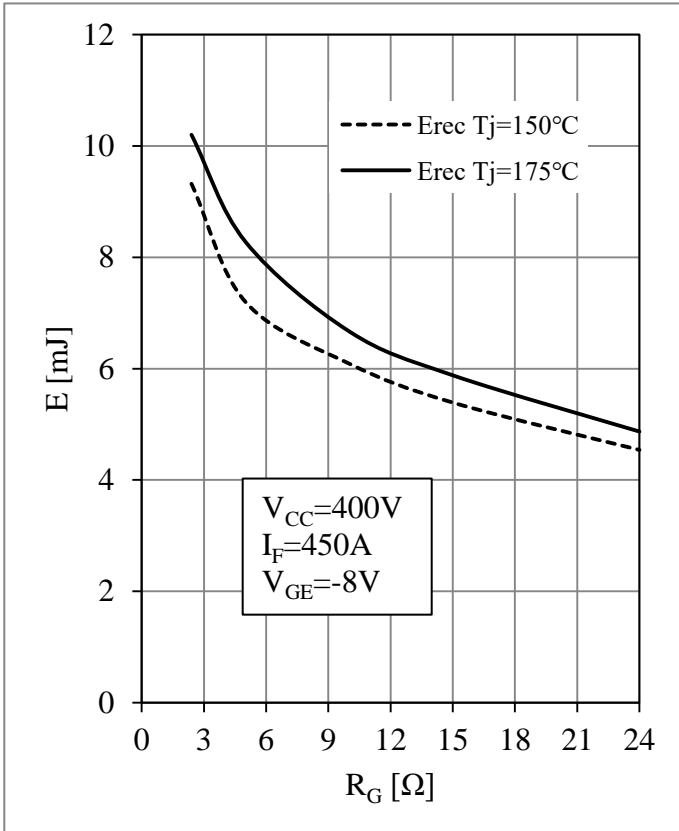


Fig 11. Diode Switching Loss vs. R_G

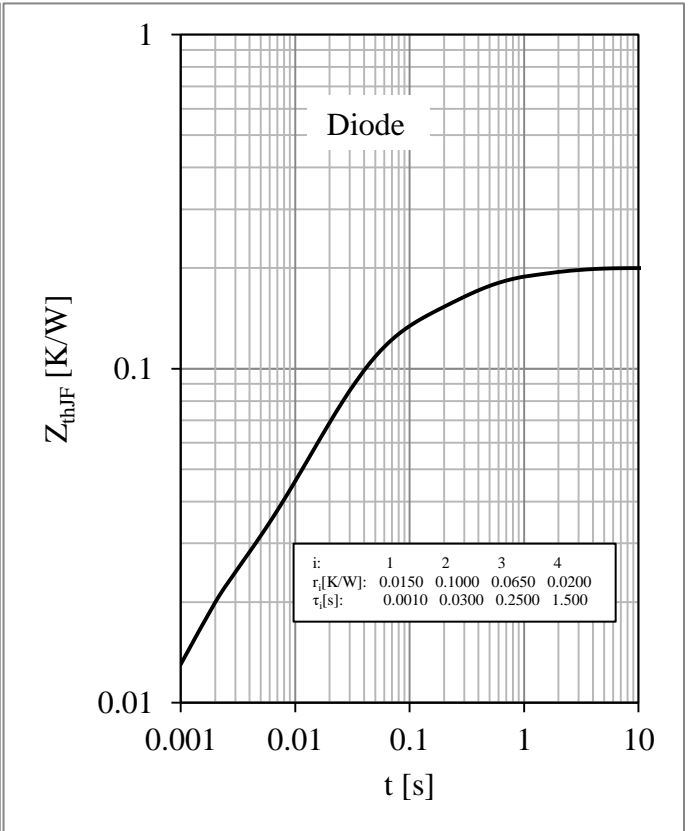


Fig 12. Diode Transient Thermal Impedance

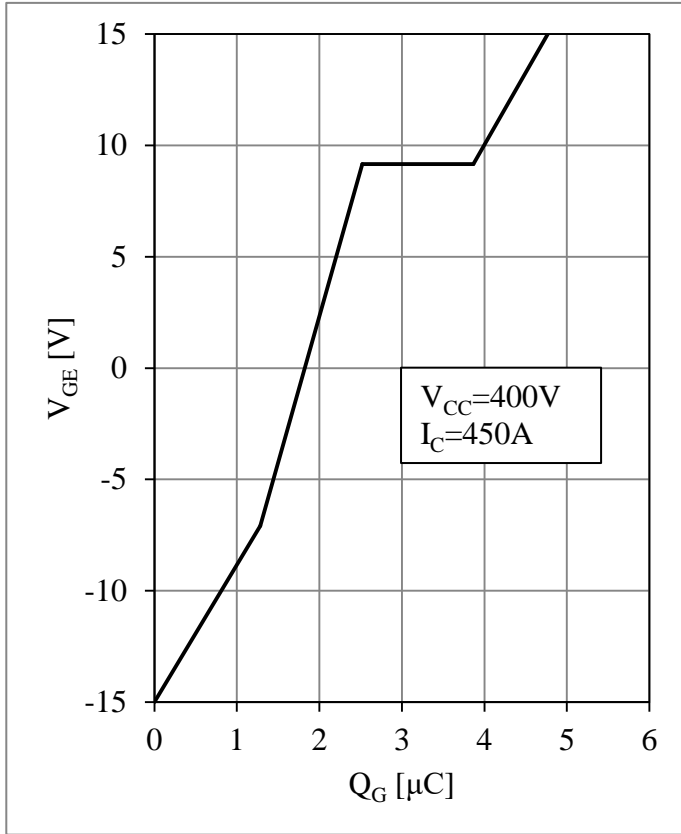


Fig 13. IGBT Gate Charge Characteristic

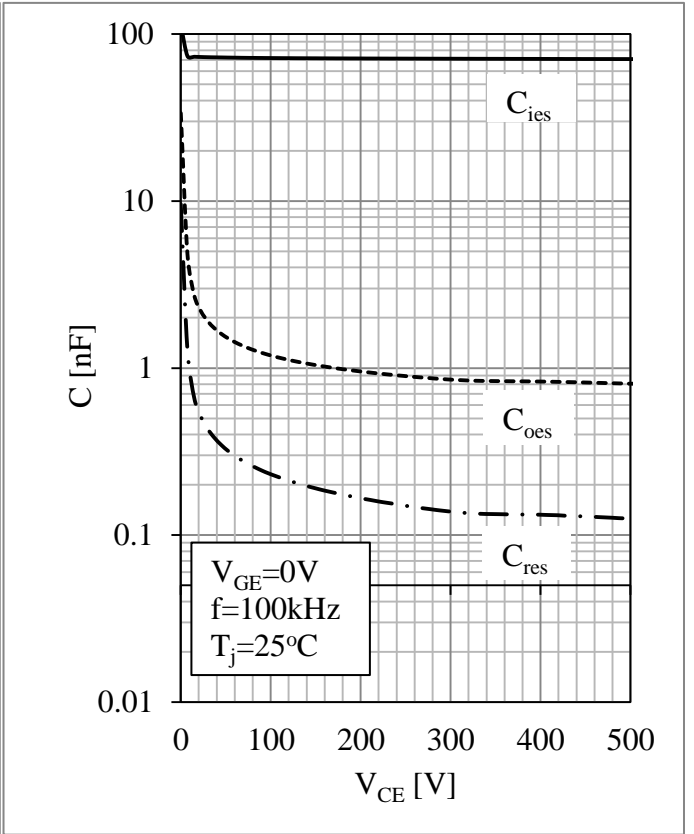


Fig 14. IGBT Capacity Characteristic

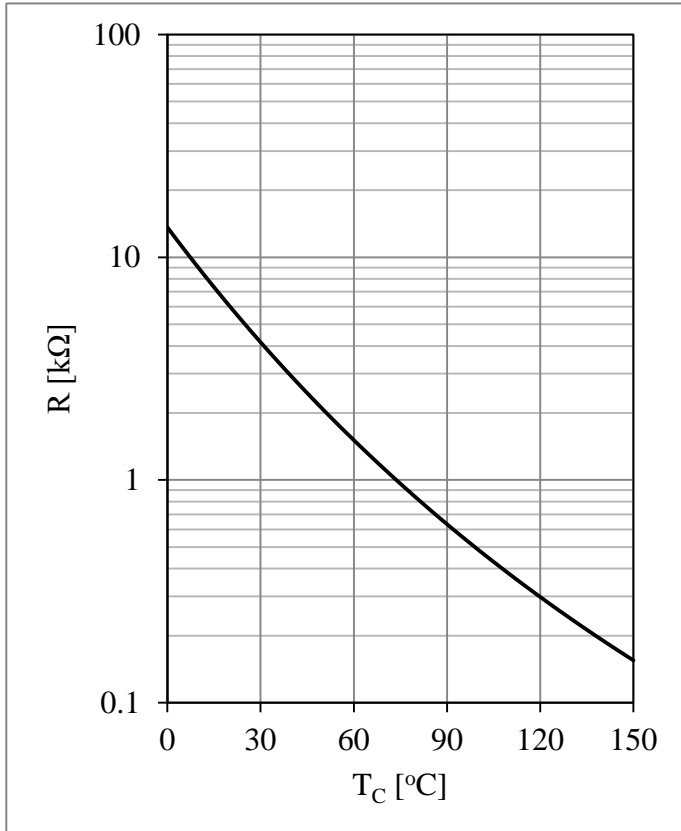


Fig 15. NTC Temperature Characteristic

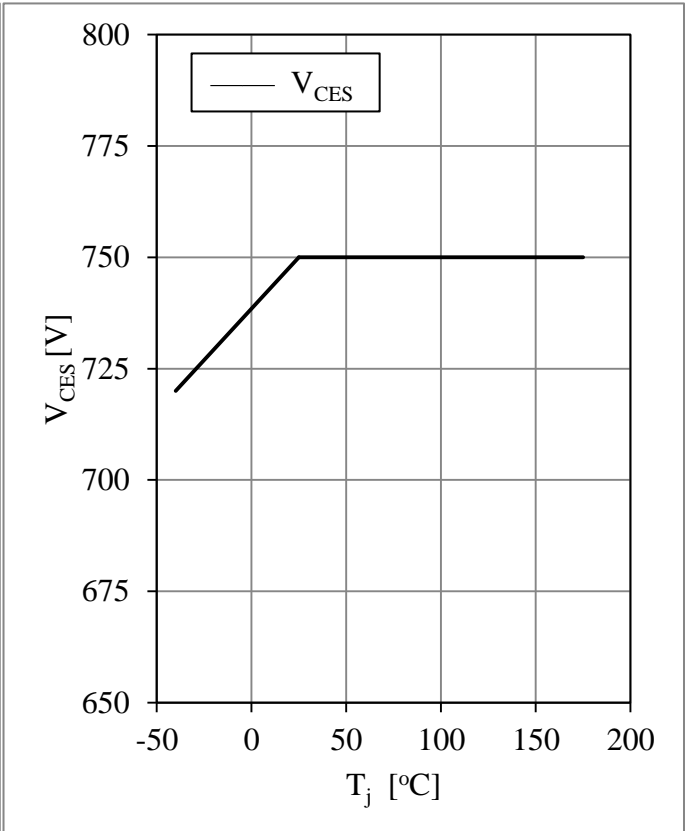
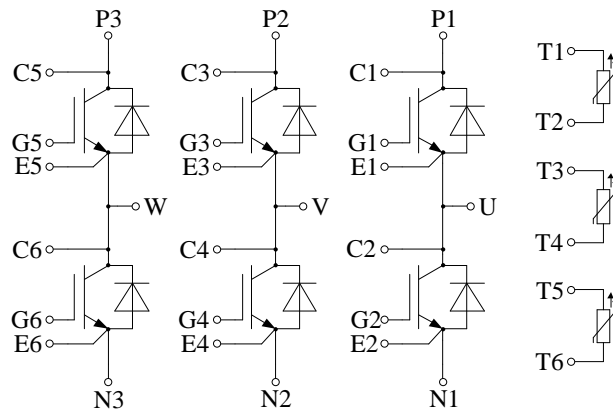


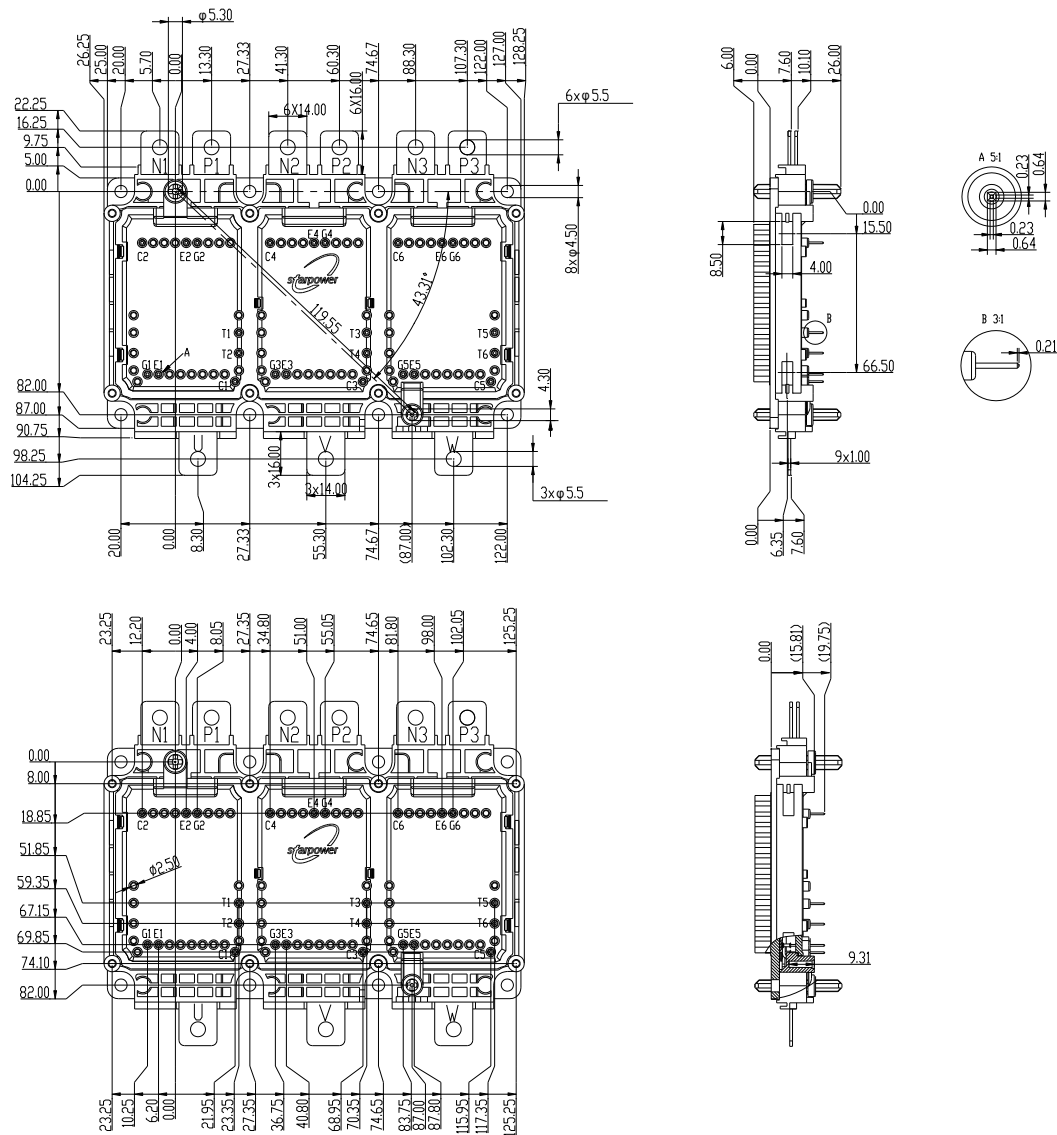
Fig 16. Maximum Allowed Collector-Emitter Voltage

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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